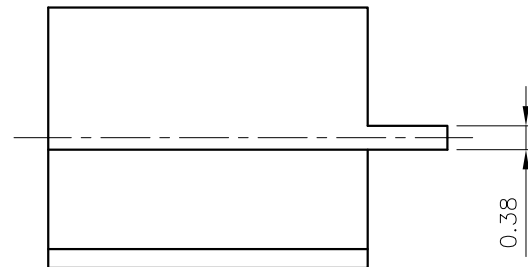
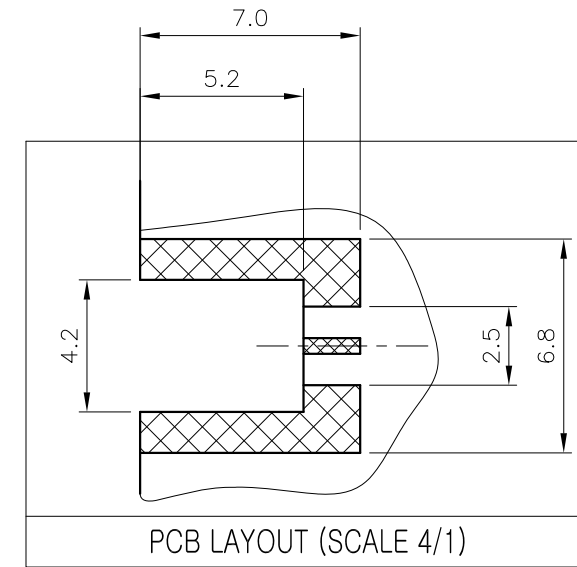
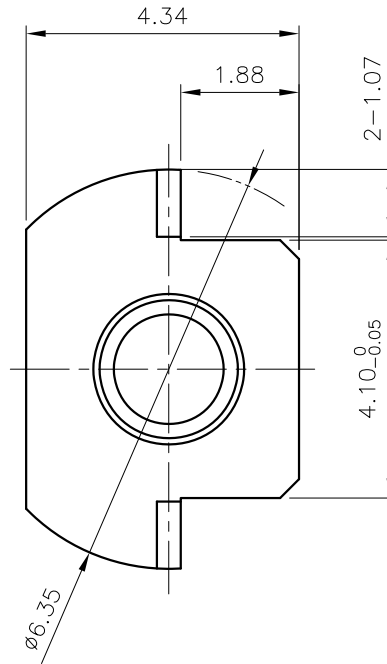
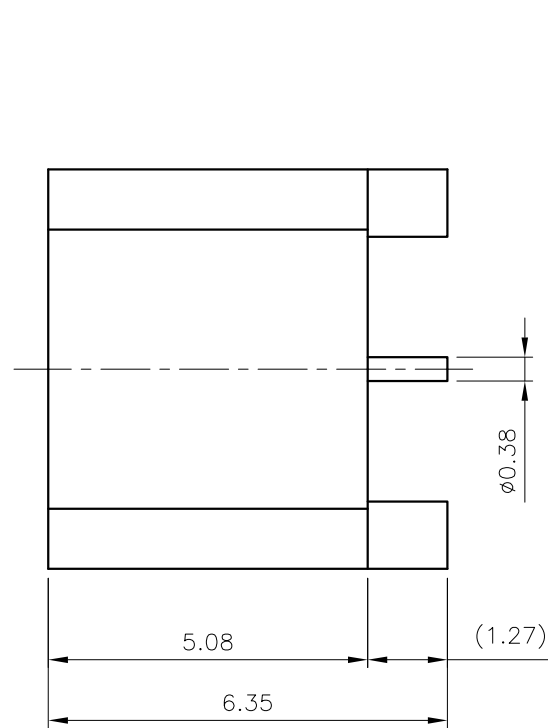
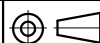


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2017. 10. 16.
1	[설번No.202111-0009] 핀 조립성 개선으로 인한 뉘시바늘 위치 변경	S.Y.EUN	I.C.KIM	2021. 11. 30.



3	INSULATOR	1	TEFLON		DIN02949-N/1
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT03887-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04358-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2021. 11. 30.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY I.C.KIM				
MATERIAL _____		CHECKED BY		TITLE SMP50 SOLDER END PS-2R(Edge) LIMITED DETENT		
		DRAWN BY S.Y.EUN				
FINISH _____		SCALE 8/1	UNIT mm		A4	DWG NO. CN03737-7/1
						REVISION 1